

APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention	ATOMIC LAYER DEPOSITION OF NOBLE METALS	
Application Type: regular, utility Attorney Docket Number: 0094.074A		
Correspondence address: Customer Number: 23405 *23405*		
Continuing Data: This is a National Stage of US application number PCT/US03/32644, filed 2003-10-15 , now Pending.		
Priority Data: Doc.No: 60/418,519; Country - US; Date: 2002-10-15 us-priority-claimed		
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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

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